

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT8161895

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TAKESHI MURASAKI	08/17/2023
RECEIVING PARTY DATA	
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State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17237271
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SIGNATURE:	/David M. Tennant/
DATE SIGNED:	09/12/2023
Total Attachments: 2	
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SEMICONDUCTOR DEVICE

And which is disclosed in the U.S. patent application executed on even date herewith, or if not so executed, was disclosed in:

- And in and to the above application and any legal equivalent thereof in a foreign country, including the right to claim priority, and in and to any division, continuation or continuation-in-part, renewal or substitute thereof, and in and to all resulting Letters Patents or any reissue, reexamination certificate, supplemental examination certificate, post grant review certificate, inter partes review certificate, or otherwise, thereof, to have and to hold the same to the full end of the term or terms for which any and all of said Letters Patent may be granted;

ASSIGNOR(S) hereby covenant(s) that ASSIGNOR(S) has/have the full power to make this assignment, and that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment; and

Without further payment or compensation by the ASSIGNEE or its successors and assigns, ASSIGNOR(S) further covenant(s) and agree(s) to communicate to said ASSIGNEE or its representatives, agents, its successors or assigns, any facts relating to said invention or inventions including evidence for purposes of interference, derivation or other administrative or legal proceedings whenever requested; to testify in any interference, legal or administrative proceedings, whenever requested; to execute and deliver, on request, all lawful papers required to make any of the foregoing provisions effective; and to do everything possible to aid said ASSIGNEE, its successors or assigns and nominees to secure, obtain and enforce proper patent protection for said invention or inventions in this or any foreign country.

Any attorney of record is authorized and requested by the execution of this assignment to insert into this assignment any further information necessary for recordation of this document.

IN WITNESS WHEREOF, the **ASSIGNOR(S)** has/have hereunto affixed his/her/their signatures on the date below written.

1)	<u>/Takeshi MURASAKI/</u>	<u>Takeshi MURASAKI</u>	<u>08/17/2023</u>
	(Signature)	(Type or Print Name)	(Date)